504379219 05/23/2017

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT4425914

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SHUNPEI YAMAZAKI	12/16/2014
YOSHINORI ANDO	12/18/2014

RECEIVING PARTY DATA

Name:	SEMICONDUCTOR ENERGY LABORATORY CO., LTD.
Street Address:	398, HASE
City:	ATSUGI-SHI, KANAGAWA-KEN
State/Country:	JAPAN
Postal Code:	243-0036

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15485371

CORRESPONDENCE DATA

Fax Number: (877)769-7945

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: (202) 783-5070 Email: APSI@fr.com Correspondent Name: JOHN F. HAYDEN

Address Line 1: FISH & RICHARDSON P.C.

Address Line 2: P.O.BOX 1022

Address Line 4: MINNEAPOLIS, MINNESOTA 55440-1022

ATTORNEY DOCKET NUMBER:	12732-1405002
NAME OF SUBMITTER:	JANELLE A. JACKSON
SIGNATURE:	/Janelle A. Jackson/
DATE SIGNED:	05/23/2017

Total Attachments: 1

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PATENT REEL: 042467 FRAME: 0246 504379219

ASSIGNMENT

For valuable consideration, We, <u>Shunpei YAMAZAKI of Setagaya</u>, <u>Tokyo</u>, <u>Japan and Yoshinori ANDO of Atsugi</u>, <u>Kanagawa</u>, <u>Japan</u> hereby assign to <u>Semiconductor Energy Laboratory Co.</u>, <u>Ltd.</u>, a <u>Japanese</u> corporation having a place of business at:

398, Hase, Atsugi-shi, Kanagawa-ken, 243-0036 Japan

and its successors an	d assigns (colle	ectively hereinal	ter called "the As	signee"), the entire righ	nt, title and
interest throughout th	e world in the	inventions and i	mprovements which	ch are subject of an app	lication for
United States Par	tent signed	by us this	day, entitled	SEMICONDUCTOR	DEVICE,
filed December 22, 2	2014 , and	l assigned U.S.	Serial Number _	14/579,249	and we
authorize and request	the attorneys a	ppointed in said	application to her	eafter complete this ass	ignment by
inserting above the fil	ing date and ser	ial number of sa	id application whe	n known; this assignmen	nt including
said application, any	and all United	States and for	eign patents, utilit	y models, and design r	egistrations
granted for any of said	d inventions or i	mprovements, ai	nd the right to clain	n priority based on the fi	ling date of
said application unde	r the Internatio	nal Convention	for the Protection	of Industrial Property,	the Patent
Cooperation Treaty,	the European F	atent Convention	on, and all other	treaties of like purpose	es; and we
authorize the Assigne	e to apply in all	countries in ou	r name or in its ov	vn name for patents, util	ity models,
design registrations a	and like rights	of exclusion an	d for inventors' c	ertificates for said inve	entions and
improvements; and v	ve agree for ou	rselves and our	respective heirs,	legal representatives a	nd assigns,
without further compe	ensation to perfo	rm such lawful a	acts and to sign suc	h further applications, as	ssignments,
Preliminary Statement	ts and other lav	vful documents	as the Assignee ma	ay reasonably request to	effectuate
fully this assignment.					

Signature	Sleyes Jamephy
Name:	Shunpei YAMAZAKI
Date:	12/11/2018
Signature	Yoshinori ANDO
Name:	Yoshinori ANDO
Date:	12 / 18 / 2014

RECORDED: 05/23/2017

PATENT REEL: 042467 FRAME: 0247